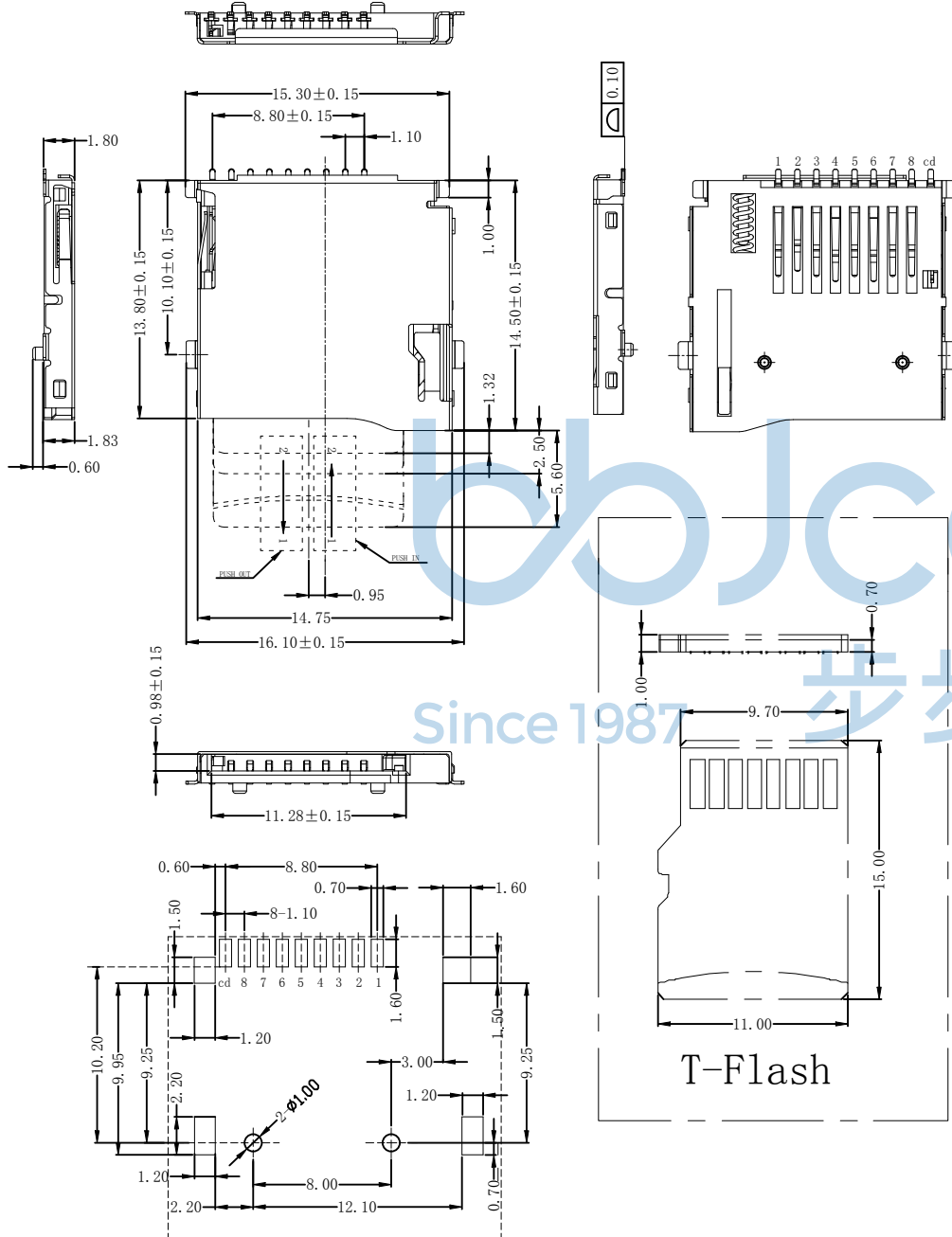
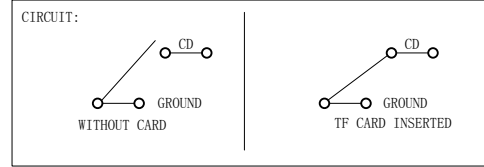


REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



- 一. 材料及其电镀规格:
1. 外壳: 不锈钢, 电镀镍底
 2. 端子: 磷铜; 电镀镍底, 锡脚 (上锡区域) 镀锡, 弹高(接触区域) 刷金;
 3. 主体/滑块: LCP;
 4. 弹簧: SWP;
 5. 拉杆: 不锈钢;
- 二. 产品性能:
1. 接触阻抗: 100 mΩ MAX;
 2. 耐电压: AC 500V 1min 无击穿, 漏电流;
 3. 绝缘阻抗: 1000MΩ MIN. 500V DC 测试时长1分钟;
 4. 插/退卡力: 0.5Kgf~1.2Kgf;



NO.	ASSIGNMENT	NO.	ASSIGNMENT
1#	DAT2	5#	CLK
2#	CD/DAT3 ²	6#	VSS
3#	CMD	7#	DAT0
4#	VDD	8#	DAT1

(RECOMMENDED/P. C. B) HOLE LAYOUT
COMPONENT SIDE VIEW TOLERANCE: ±0.05

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PDWG.NO: 0023-1

APPD. JM_Zheng
CHKD. LYX
DR. TSP

深圳市步步精科技有限公司

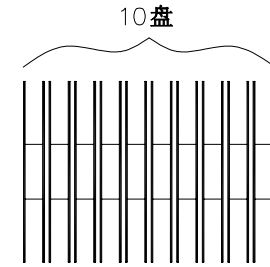
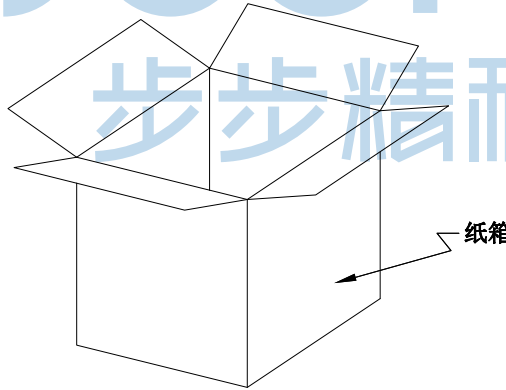
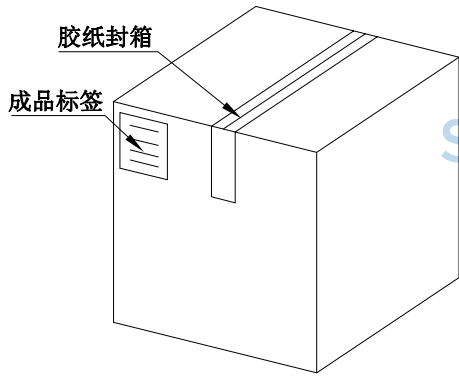
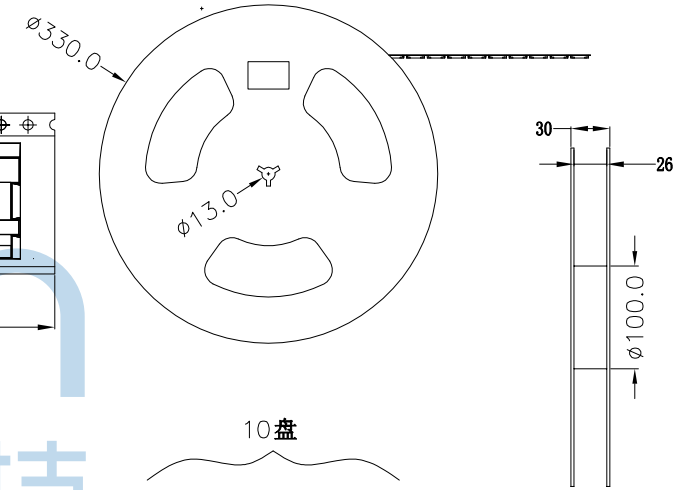
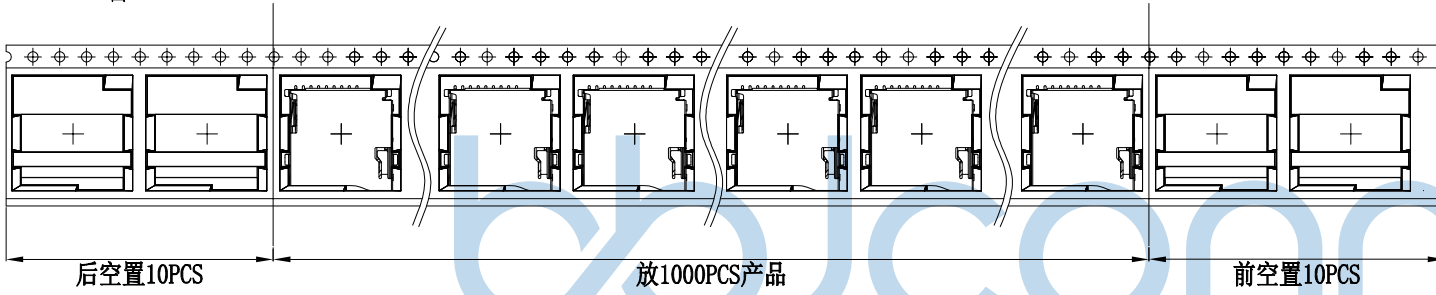
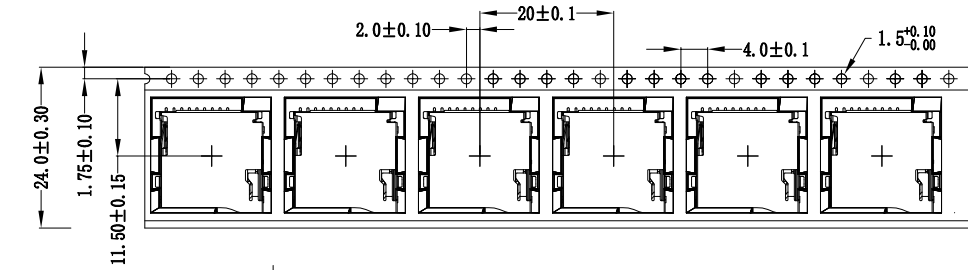
NAME: 卡座 TF 外焊自弹 8P 带CD PIN
H=1.80 贴片 带柱 冷封编带

PJ. NO.: CD.01.02-01-0001
SIZE: A4 DRW NO.:
FINISH: SEE NOTES MAT'L.: SEE NOTES
SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

包装方式:

- 1 将卷带放入包装机后, 前空10PCS, 后放产品1000PCS, 再后空10PCS;
- 2 将包装好的产品从包装机上取下, 用美纹胶纸封口, 再使用封口透明带缠绕其一圈后用美纹胶纸封口;
- 3 把累叠好的10盘叠放入纸箱中共计10Kset;
- 4 把包装好的成品打包封箱, 并在纸箱外贴上标签



纸箱规格: 345*345*310



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.X: ±0.38	X': ±3'	NAME: 卡座 TF 外焊自弹 8P 带CDPIN H=1.80 贴片 带柱 冷封编带	
.XX: ±0.25	.X': ±2'	APPD.: JM_Zheng	PJ. NO.: CD.01.02-01-0001
.XXX: ±0.13	.XX': ±1'	CHKD.: LYX	SIZE: A4 DRW NO.:
PDWG.NO: 0023-1	DR.: TSP	FINISH: SEE NOTES	MAT'L.: SEE NOTES
		SCALE: N/A	REV.: A0 UNIT: mm PAGE: 2/2